# 60V, 55A, 11.1m $\Omega$ N-channel Power Trench MOSFET

### JMTC110N06A

#### **Features**

- $\bullet$   $\;$  Excellent  $R_{DS(ON)}$  and Low Gate Charge
- 100% UIS Tested
- 100% ΔVds Tested
- Halogen-free; RoHS-compliant

### **Applications**

- Load Switch
- PWM Application
- Power Management

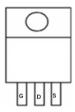
### **Product Summary**

Parameters	Value	Unit
$V_{DSS}$	60	V
$V_{GS(th)\_Typ}$	3	V
$I_{D}(@V_{GS}=10V)$	55	Α
$R_{DS(ON)\_Typ}(@V_{GS}=10V$	11.1	mΩ

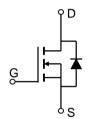








Pin Assignment



**Schematic Diagram** 

Ordering Information

Device	Marking	MSL	Form	Package	Reel(pcs)	Per Carton (pcs)
JMTC110N06A	JMTC110N06A	NA	Tape&Reel	TO-220-3L	50	5000

### Absolute Maximum Ratings (@ T<sub>C</sub> = 25°C unless otherwise specified)

Symbol	Parameter		Value	Unit
$V_{DS}$	Drain-to-Source Voltage		60	V
$V_{GS}$	Gate-to-Source Voltage	Gate-to-Source Voltage		V
	Continuous Drain Current	$T_C = 25^{\circ}C$	55	^
I <sub>D</sub>	Continuous Drain Current	$T_C = 100$ °C	35	— A
$I_{DM}$	Pulsed Drain Current (1)	Pulsed Drain Current (1)		Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy (2)		103	mJ
$P_{D}$	Power Dissipation	$T_C = 25^{\circ}C$	96	W
' D	Fower Dissipation	$T_C = 100$ °C	38	VV
$T_{J}, T_{STG}$	Junction & Storage Temperature Range		-55 to 150	°C

#### **Thermal Characteristics**

Symbol	Parameter	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (3)	40	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.3	C/VV



### **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

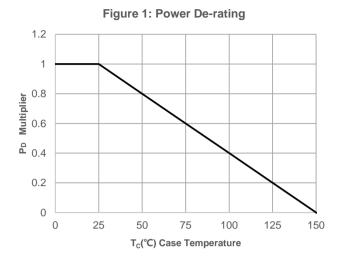
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	aracteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	60	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 60V, V_{GS} = 0V$	-	-	1.0	μА
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 25V$	-	-	±100	nA
On Cha	racteristics					
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.1	3	4.1	V
R <sub>DS(ON)</sub>	Static Drain-Source ON-Resistance <sup>(4)</sup>	$V_{GS} = 10V, I_{D} = 30A$	-	11.1	14.5	mΩ
Dynam	ic Characteristics					
$R_{g}$	Gate Resistance	f = 1MHz	-	1.6	-	Ω
C <sub>iss</sub>	Input Capacitance	., ., ., ., ., ., ., ., ., ., ., ., ., .	1428	1999	2698	pF
C <sub>oss</sub>	Output Capacitance	$V_{GS} = 0V$ , $V_{DS} = 30V$ , $f = 1MHz$	114	159	215	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 11/11/12	103	144	194	pF
$Q_g$	Total Gate Charge		34	48	64	nC
$Q_{gs}$	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 30V, I_{D} = 30A$	9	13	17	nC
$Q_{gd}$	Gate Drain("Miller") Charge	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 30/V	13	18	25	nC
Switchi	ing Characteristics					
t <sub>d(on)</sub>	Turn-On DelayTime			12	T _	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 30V$		28	_	ns
t <sub>d(off)</sub>	Turn-Off DelayTime	$I_D = 30A$ , $R_{GEN} = 3\Omega$	_	29	_	ns
t <sub>f</sub>	Turn-Off Fall Time	-	-	11	-	ns
Body D	iode Characteristics					L
I <sub>S</sub>	Maximum Continuous Body Diode Forward Current		-	-	55	Α
I <sub>SM</sub>	Maximum Pulsed Body Diode Forward Current		-	-	221	Α
V <sub>SD</sub>	Body Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 30A$	-		1.2	V
trr	Body Diode Reverse Recovery Time	1 20A di/dt 100A/:	16	23	31	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 20A$ , di/dt = 100A/us	-	26	-	nC

Notes:

- 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
- $2.~E_{AS}~condition:~Starting~T_{J}=25C,~V_{DD}=30V,~V_{GS}=10V,~R_{G}=25ohm,~L=0.5mH,~I_{AS}=20.3A,~V_{DD}=0V~during~time~in~avalanche.$
- 3.  $\rm R_{\rm \theta JA}$  is measured with the device mounted on a 1inch  $^{2}$  pad of 2oz copper FR4 PCB.
- 4. Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%.



# **Typical Performance Characteristics**



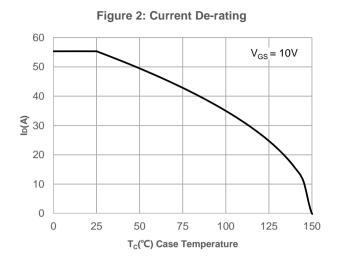
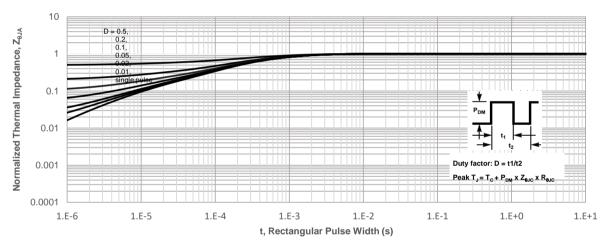
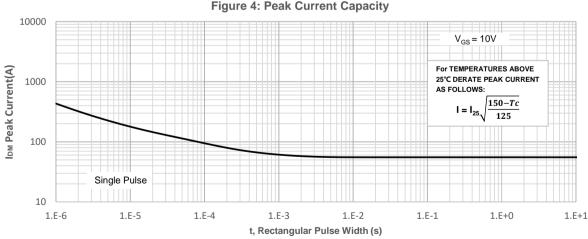


Figure 3: Normalized Maximum Transient Thermal Impedance







## **Typical Performance Characteristics**

Figure 5: Output Characteristics

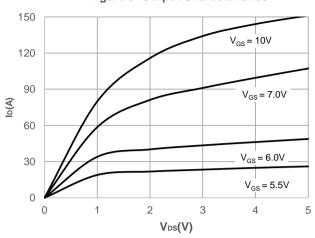


Figure 6: Typical Transfer Characteristics

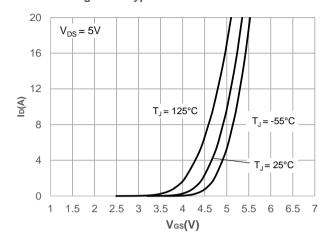


Figure 7: On-resistance vs. Drain Current

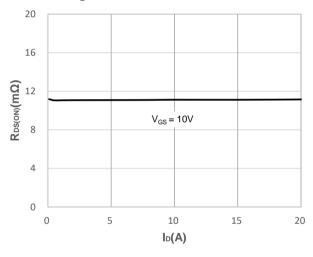


Figure 8: Body Diode Characteristics

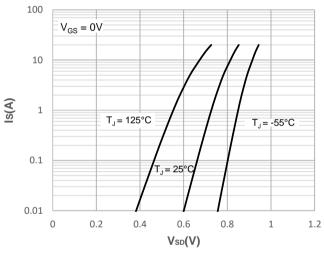


Figure 9: Gate Charge Characteristics

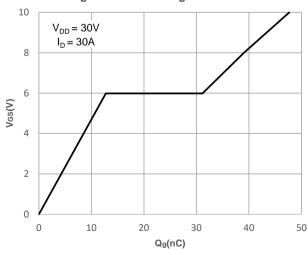
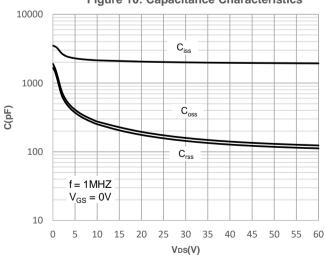


Figure 10: Capacitance Characteristics





# **Typical Performance Characteristics**

Figure 11: Normalized Breakdown voltage vs.
Junction Temperature

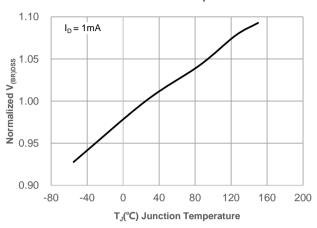


Figure 13: Normalized Threshold Voltage vs.
Junction Temperature

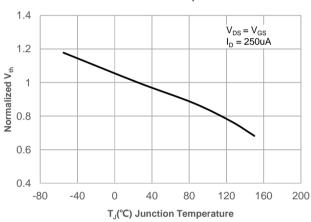


Figure 15: Maximum Safe Operating Area

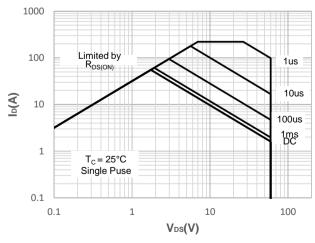
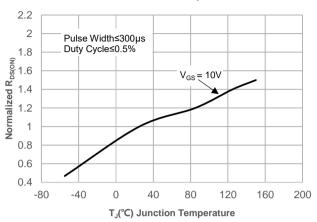
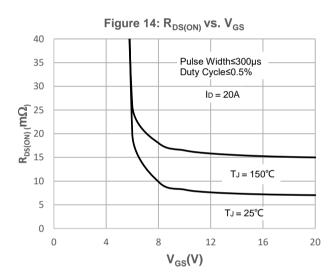


Figure 12: Normalized on Resistance vs.
Junction Temperature







### **Test Circuit**

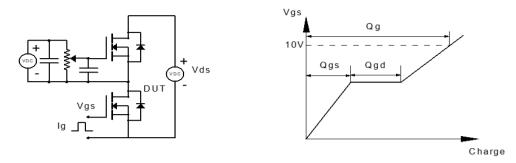


Figure 1: Gate Charge Test Circuit & Waveform

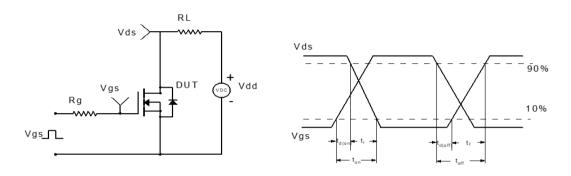


Figure 2: Resistive Switching Test Circuit & Waveform

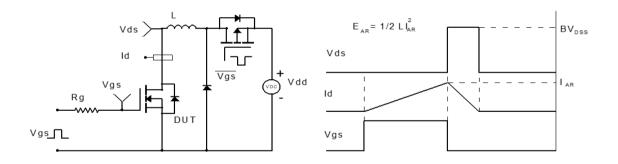


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

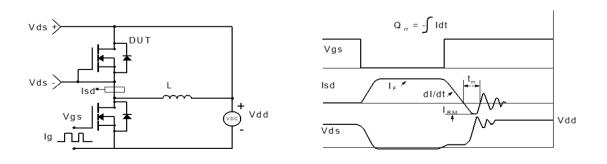
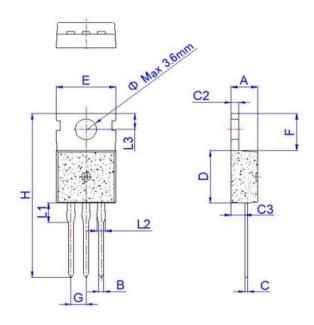


Figure 4: Diode Recovery Test Circuit & Waveform



### Package Mechanical Data(TO-220-3L)

#### **Package Outline**



	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	4.40		4.60	0.173		0.181	
В	0.70		0.90	0.028		0.035	
С	0.45		0.60	0.018		0.024	
C2	1.23		1.32	0.048		0.052	
C3	2.20		2.60	0.087		0.102	
D	8.90		9.90	0.350		0.390	
Е	9.90		10.3	0.390		0.406	
F	6.30		6.90	0.248		0.272	
G		2.54			0.1		
Н	28.0		29.8	1.102		1.173	
L1		3.39			0.133		
L2	1.14		1.70	0.045		0.067	
L3	2.65		2.95	0.104		0.116	
Φ		3.6			0.142		

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